

EAST Search History

S2	431	capillary.clm. and bonding.clm. and semiconductor	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/06/25 20:50
S3	212	capillary.clm. and bonding.clm. and semiconductor.clm.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/12/01 17:32
S4	73	capillary.clm. and bonding.clm. and semiconductor.clm. and tool	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/06/25 22:23
S5	0	ceramic.clm. and capillary.in. and bonding.clm.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/06/25 20:51
S6	0	ceramic.clm. and capillary.in.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/12/01 15:41
S7	572	ceramic.clm. and capillary.clm.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/06/25 20:51
S8	181	ceramic.clm. and capillary.clm. and bonding	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/06/27 01:28
S9	57	ceramic.clm. and capillary.clm. and bonding.clm.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/06/25 20:57

EAST Search History

S10	572	ceramic.clm. and capillary.clm.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/11/26 19:16
S11	34	ceramic.clm. and capillary.clm. and "264"/\$8.ccls.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/06/25 21:01
S12	181	ceramic.clm. and capillary.clm. and bonding	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2006/03/28 12:52
S13	57	ceramic.clm. and capillary.clm. and bonding.clm.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/06/25 21:01
S14	51	ceramic.clm. and capillary.clm. and bonding.clm. and process	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/06/25 22:06
S15	46	("2892924" "3538205" "3660050" "3986653" "4020543" "4171477" "4182947" "4315128" "4331048" "4387283" "4390771" "4502983" "4513190" "4691854" "4705204" "4897710" "4909427" "4998002" "5178742" "5180093" "5214259" "5217154" "5280979" "5290507" "5367956" "5463197" "5463896" "5491605" "5527441" "5544804" "5601740" "5616257" "5649355" "5651901" "5676856" "5797388" "5816472" "5827470" "5931368" "6030472" "6073827").PN. OR ("6354479"). URPN.	US-PGPUB; USPAT; USOCR	OR	OFF	2005/06/25 21:50
S16	9	"6374479"	US-PGPUB; USPAT; USOCR	OR	OFF	2005/06/25 21:50

EAST Search History

S17	10	ceramic.clm. and capillary.clm. and bonding.clm. and binder	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/06/25 22:06
S18	17	ceramic.clm. and capillary.clm. and bonding.clm. and (binder or thermoplastic)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/06/25 22:16
S19	898	capillary.clm. and bonding.clm.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/06/27 01:28
S20	431	capillary.clm. and bonding.clm. and semiconductor	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/06/27 01:28
S21	212	capillary.clm. and bonding.clm. and semiconductor.clm.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/06/27 14:49
S22	898	S19 or S20 or S21	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/06/27 01:28
S23	73	capillary.clm. and bonding.clm. and semiconductor.clm. and tool	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/06/27 01:29
S24	0	ceramic.clm. and capillary.in. and bonding.clm.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/06/27 01:29

EAST Search History

S25	0	ceramic.clm. and capillary.in.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/06/27 01:29
S26	572	ceramic.clm. and capillary.clm.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/06/27 01:29
S27	181	ceramic.clm. and capillary.clm. and bonding	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/06/27 01:29
S28	57	ceramic.clm. and capillary.clm. and bonding.clm.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/06/27 01:29
S29	572	ceramic.clm. and capillary.clm.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/06/27 01:29
S30	34	ceramic.clm. and capillary.clm. and "264"/\$8.ccls.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/06/27 01:29
S31	181	ceramic.clm. and capillary.clm. and bonding	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/06/27 01:29
S32	57	ceramic.clm. and capillary.clm. and bonding.clm.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/06/27 01:29

EAST Search History

S33	51	ceramic.clm. and capillary.clm. and bonding.clm. and process	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/06/27 01:29
S34	9	"6374479"	US-PGPUB; USPAT; USOCR	OR	OFF	2005/06/27 01:29
S35	17	ceramic.clm. and capillary.clm. and bonding.clm. and (binder or thermoplastic)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/06/27 01:29
S36	314	264/669.ccls.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/06/27 01:29
S37	250	264/670.ccls.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/06/27 01:29
S38	299	264/614.ccls.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/06/27 01:29
S39	104	264/629.ccls.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/06/27 01:29
S40	1404	228/4.5.ccls.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/06/27 01:30
S41	2	"11156568"	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/06/27 12:57

EAST Search History

S42	3	yamate.in. and color.clm.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/06/27 13:05
S43	0	65/31.1.ccls.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/06/27 13:05
S44	0	65/31.11.ccls.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/06/27 13:05
S45	845	65/111.ccls.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/06/27 13:05
S46	112	65/111.ccls. and color	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/06/27 13:06
S47	7	65/111.ccls. and color.clm.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/06/27 13:05
S48	155	photolithography and blanks and cutting	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/06/27 14:49
S49	49	"5558270"	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/11/26 14:56

EAST Search History

S50	76	"5421503"	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/11/26 14:57
S51	73	"5217154"	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/11/26 14:57
S52	11	"4667867"	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/11/26 14:57
S53	76	"5421503"	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/11/26 19:16
S54	8	"4049506"	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/11/26 19:18
S55	11	"5890643"	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/11/26 19:27
S56	2	"6409463"	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/11/26 19:27
S57	5	"6080445"	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/11/26 19:28

EAST Search History

S58	5	"5741842"	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/11/26 19:28
S59	2	"20020158374"	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/11/26 19:28
S60	944	capillary.clm. and bonding.clm.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/11/26 19:31
S61	453	capillary.clm. and bonding.clm. and semiconductor	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/11/26 19:31
S62	222	capillary.clm. and bonding.clm. and semiconductor.clm.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/11/26 19:31
S63	76	capillary.clm. and bonding.clm. and semiconductor.clm. and tool	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/11/26 19:31
S64	0	ceramic.clm. and capillary.in. and bonding.clm.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/11/26 19:31
S65	0	ceramic.clm. and capillary.in.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/11/26 19:31

EAST Search History

S66	602	ceramic.clm. and capillary.clm.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/11/26 19:31
S67	192	ceramic.clm. and capillary.clm. and bonding	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/11/26 19:31
S68	61	ceramic.clm. and capillary.clm. and bonding.clm.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/11/26 19:31
S69	602	ceramic.clm. and capillary.clm.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/11/26 19:31
S70	34	ceramic.clm. and capillary.clm. and "264"/\$8.ccls.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/11/26 19:31
S71	192	ceramic.clm. and capillary.clm. and bonding	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/11/26 19:31
S72	61	ceramic.clm. and capillary.clm. and bonding.clm.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/11/26 19:31
S73	54	ceramic.clm. and capillary.clm. and bonding.clm. and process	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/11/26 19:31

EAST Search History

S74	49	("2892924" "3538205" "3660050" "3986653" "4020543" "4171477" "4182947" "4315128" "4331048" "4387283" "4390771" "4502983" "4513190" "4691854" "4705204" "4897710" "4909427" "4998002" "5178742" "5180093" "5214259" "5217154" "5280979" "5290507" "5367956" "5463197" "5463896" "5491605" "5527441" "5544804" "5601740" "5616257" "5649355" "5651901" "5676856" "5797388" "5816472" "5827470" "5931368" "6030472" "6073827").PN. OR ("6354479"). URPN.	US-PGPUB; USPAT; USOCR	OR	OFF	2005/11/26 19:31
S75	13	"6374479"	US-PGPUB; USPAT; USOCR	OR	OFF	2005/11/26 19:31
S76	11	ceramic.clm. and capillary.clm. and bonding.clm. and binder	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/11/26 19:31
S77	18	ceramic.clm. and capillary.clm. and bonding.clm. and (binder or thermoplastic)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/11/26 19:31
S78	944	capillary.clm. and bonding.clm.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/11/26 19:31
S79	453	capillary.clm. and bonding.clm. and semiconductor	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/11/26 19:31
S80	222	capillary.clm. and bonding.clm. and semiconductor.clm.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/11/26 19:31

EAST Search History

S81	944	S78 or S79 or S80	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/11/26 19:31
S82	76	capillary.clm. and bonding.clm. and semiconductor.clm. and tool	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/11/26 19:31
S83	0	ceramic.clm. and capillary.in. and bonding.clm.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/11/26 19:31
S84	0	ceramic.clm. and capillary.in.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/11/26 19:31
S85	602	ceramic.clm. and capillary.clm.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/11/26 19:31
S86	192	ceramic.clm. and capillary.clm. and bonding	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/11/26 19:31
S87	61	ceramic.clm. and capillary.clm. and bonding.clm.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/11/26 19:31
S88	602	ceramic.clm. and capillary.clm.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/11/26 19:31

EAST Search History

S89	34	ceramic.clm. and capillary.clm. and "264"/\$8.ccls.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/11/26 19:31
S90	192	ceramic.clm. and capillary.clm. and bonding	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/11/26 19:31
S91	61	ceramic.clm. and capillary.clm. and bonding.clm.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/11/26 19:31
S92	54	ceramic.clm. and capillary.clm. and bonding.clm. and process	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/11/26 19:31
S93	13	"6374479"	US-PGPUB; USPAT; USOCR	OR	OFF	2005/11/26 19:31
S94	18	ceramic.clm. and capillary.clm. and bonding.clm. and (binder or thermoplastic)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/12/01 17:16
S95	316	264/669.ccls.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/11/26 19:31
S96	250	264/670.ccls.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/11/26 19:31
S97	303	264/614.ccls.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/11/26 19:31

EAST Search History

S98	106	264/629.ccls.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/11/26 19:31
S99	1426	228/4.5.ccls.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/11/26 19:31
S10 0	3	"11156568"	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/11/26 19:31
S10 1	4	yamate.in. and color.clm.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/11/26 19:31
S10 2	0	65/31.1.ccls.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/11/26 19:31
S10 3	0	65/31.11.ccls.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/11/26 19:31
S10 4	852	65/111.ccls.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/11/26 19:31
S10 5	7	65/111.ccls. and color.clm.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/11/26 19:31

EAST Search History

S10 6	113	65/111.ccls. and color	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/11/26 19:31
S10 7	165	photolithography and blanks and cutting	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/11/26 19:31
S10 8	49	"5558270"	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/11/26 19:31
S10 9	76	"5421503"	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/11/26 19:31
S11 0	73	"5217154"	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/11/26 19:31
S11 1	11	"4667867"	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/11/26 19:31
S11 2	1	10/082867	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/12/01 15:41
S11 3	182	264/610.ccls.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/12/01 17:16

EAST Search History

S11 4	289	264/628.ccls.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/12/01 17:16
S11 5	944	capillary.clm. and bonding.clm.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/12/01 17:16
S11 6	453	capillary.clm. and bonding.clm. and semiconductor	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/12/01 17:16
S11 7	222	capillary.clm. and bonding.clm. and semiconductor.clm.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/12/01 17:16
S11 8	76	capillary.clm. and bonding.clm. and semiconductor.clm. and tool	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/12/01 17:16
S11 9	0	ceramic.clm. and capillary.in. and bonding.clm.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/12/01 17:16
S12 0	0	ceramic.clm. and capillary.in.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/12/01 17:16
S12 1	603	ceramic.clm. and capillary.clm.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/12/01 17:16

EAST Search History

S12 2	192	ceramic.clm. and capillary.clm. and bonding	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/12/01 17:16
S12 3	61	ceramic.clm. and capillary.clm. and bonding.clm.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/12/01 17:16
S12 4	603	ceramic.clm. and capillary.clm.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/12/01 17:16
S12 5	34	ceramic.clm. and capillary.clm. and "264"/\$8.ccls.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/12/01 17:16
S12 6	192	ceramic.clm. and capillary.clm. and bonding	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/12/01 17:16
S12 7	61	ceramic.clm. and capillary.clm. and bonding.clm.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/12/01 17:16
S12 8	54	ceramic.clm. and capillary.clm. and bonding.clm. and process	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/12/01 17:16

EAST Search History

S12 9	49	("2892924" "3538205" "3660050" "3986653" "4020543" "4171477" "4182947" "4315128" "4331048" "4387283" "4390771" "4502983" "4513190" "4691854" "4705204" "4897710" "4909427" "4998002" "5178742" "5180093" "5214259" "5217154" "5280979" "5290507" "5367956" "5463197" "5463896" "5491605" "5527441" "5544804" "5601740" "5616257" "5649355" "5651901" "5676856" "5797388" "5816472" "5827470" "5931368" "6030472" "6073827").PN. OR ("6354479"). URPN.	US-PGPUB; USPAT; USOCR	OR	OFF	2005/12/01 17:16
S13 0	13	"6374479"	US-PGPUB; USPAT; USOCR	OR	OFF	2005/12/01 17:16
S13 1	11	ceramic.clm. and capillary.clm. and bonding.clm. and binder	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/12/01 17:16
S13 2	18	ceramic.clm. and capillary.clm. and bonding.clm. and (binder or thermoplastic)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/12/01 17:16
S13 3	944	capillary.clm. and bonding.clm.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/12/01 17:16
S13 4	453	capillary.clm. and bonding.clm. and semiconductor	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/12/01 17:16
S13 5	222	capillary.clm. and bonding.clm. and semiconductor.clm.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/12/01 17:16

EAST Search History

S13 6	944	S133 or S134 or S135	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/12/01 17:16
S13 7	76	capillary.clm. and bonding.clm. and semiconductor.clm. and tool	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/12/01 17:16
S13 8	0	ceramic.clm. and capillary.in. and bonding.clm.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/12/01 17:16
S13 9	0	ceramic.clm. and capillary.in.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/12/01 17:16
S14 0	603	ceramic.clm. and capillary.clm.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/12/01 17:16
S14 1	192	ceramic.clm. and capillary.clm. and bonding	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/12/01 17:16
S14 2	61	ceramic.clm. and capillary.clm. and bonding.clm.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/12/01 17:16
S14 3	603	ceramic.clm. and capillary.clm.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/12/01 17:16

EAST Search History

S14 4	34	ceramic.clm. and capillary.clm. and "264"/\$8.ccls.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/12/01 17:16
S14 5	192	ceramic.clm. and capillary.clm. and bonding	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/12/01 17:16
S14 6	61	ceramic.clm. and capillary.clm. and bonding.clm.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/12/01 17:16
S14 7	54	ceramic.clm. and capillary.clm. and bonding.clm. and process	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/12/01 17:16
S14 8	13	"6374479"	US-PGPUB; USPAT; USOCR	OR	OFF	2005/12/01 17:16
S14 9	18	ceramic.clm. and capillary.clm. and bonding.clm. and (binder or thermoplastic)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/12/01 17:16
S15 0	316	264/669.ccls.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/12/01 17:16
S15 1	250	264/670.ccls.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/12/01 17:16
S15 2	303	264/614.ccls.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/12/01 17:16

EAST Search History

S15 3	106	264/629.ccls.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/12/01 17:16
S15 4	1428	228/4.5.ccls.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/12/01 17:16
S15 5	3	"11156568"	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/12/01 17:16
S15 6	4	yamate.in. and color.clm.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/12/01 17:16
S15 7	0	65/31.1.ccls.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/12/01 17:16
S15 8	0	65/31.11.ccls.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/12/01 17:16
S15 9	852	65/111.ccls.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/12/01 17:16
S16 0	7	65/111.ccls. and color.clm.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/12/01 17:16

EAST Search History

S16 1	113	65/111.ccls. and color	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/12/01 17:16
S16 2	165	photolithography and blanks and cutting	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/12/01 17:16
S16 3	49	"5558270"	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/12/01 17:16
S16 4	76	"5421503"	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/12/01 17:16
S16 5	73	"5217154"	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/12/01 17:16
S16 6	11	"4667867"	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/12/01 17:16
S16 7	76	"5421503"	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/12/01 17:16
S16 8	8	"4049506"	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/12/01 17:16

EAST Search History

S16 9	11	"5890643"	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/12/01 17:16
S17 0	2	"6409463"	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/12/01 17:16
S17 1	5	"6080445"	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/12/01 17:16
S17 2	5	"5741842"	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/12/01 17:16
S17 3	2	"20020158374"	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/12/01 17:16
S17 4	944	capillary.clm. and bonding.clm.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/12/01 17:16
S17 5	453	capillary.clm. and bonding.clm. and semiconductor	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/12/01 17:16
S17 6	222	capillary.clm. and bonding.clm. and semiconductor.clm.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/12/01 17:16

EAST Search History

S17 7	0	ceramic.clm. and capillary.in. and bonding.clm.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/12/01 17:16
S17 8	0	ceramic.clm. and capillary.in.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/12/01 17:16
S17 9	603	ceramic.clm. and capillary.clm.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/12/01 17:16
S18 0	192	ceramic.clm. and capillary.clm. and bonding	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/12/01 17:16
S18 1	603	ceramic.clm. and capillary.clm.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/12/01 17:16
S18 2	192	ceramic.clm. and capillary.clm. and bonding	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/12/01 17:16
S18 3	61	ceramic.clm. and capillary.clm. and bonding.clm.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/12/01 17:16
S18 4	54	ceramic.clm. and capillary.clm. and bonding.clm. and process	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/12/01 17:16
S18 5	13	"6374479"	US-PGPUB; USPAT; USOCR	OR	OFF	2005/12/01 17:16

EAST Search History

S18 6	11	ceramic.clm. and capillary.clm. and bonding.clm. and binder	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/12/01 17:16
S18 7	944	capillary.clm. and bonding.clm.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/12/01 17:16
S18 8	453	capillary.clm. and bonding.clm. and semiconductor	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/12/01 17:16
S18 9	222	capillary.clm. and bonding.clm. and semiconductor.clm.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/12/01 17:16
S19 0	944	S187 or S188 or S189	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/12/01 17:16
S19 1	76	capillary.clm. and bonding.clm. and semiconductor.clm. and tool	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/12/01 17:16
S19 2	0	ceramic.clm. and capillary.in. and bonding.clm.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/12/01 17:16
S19 3	0	ceramic.clm. and capillary.in.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/12/01 17:16

EAST Search History

S19 4	603	ceramic.clm. and capillary.clm.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/12/01 17:16
S19 5	192	ceramic.clm. and capillary.clm. and bonding	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/12/01 17:16
S19 6	61	ceramic.clm. and capillary.clm. and bonding.clm.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/12/01 17:16
S19 7	603	ceramic.clm. and capillary.clm.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/12/01 17:16
S19 8	34	ceramic.clm. and capillary.clm. and "264"/\$8.ccls.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/12/01 17:16
S19 9	192	ceramic.clm. and capillary.clm. and bonding	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/12/01 17:16
S20 0	61	ceramic.clm. and capillary.clm. and bonding.clm.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/12/01 17:16
S20 1	54	ceramic.clm. and capillary.clm. and bonding.clm. and process	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/12/01 17:16
S20 2	13	"6374479"	US-PGPUB; USPAT; USOCR	OR	OFF	2005/12/01 17:16

EAST Search History

S20 3	18	ceramic.clm. and capillary.clm. and bonding.clm. and (binder or thermoplastic)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/12/01 17:16
S20 4	316	264/669.ccls.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/12/01 17:16
S20 5	250	264/670.ccls.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/12/01 17:16
S20 6	303	264/614.ccls.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/12/01 17:16
S20 7	106	264/629.ccls.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/12/01 17:16
S20 8	1428	228/4.5.ccls.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/12/01 17:16
S20 9	0	65/31.1.ccls.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/12/01 17:16
S21 0	0	65/31.11.ccls.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/12/01 17:16

EAST Search History

S21 1	852	65/111.ccls.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/12/01 17:16
S21 2	76	capillary.clm. and bonding.clm. and semiconductor.clm. and tool	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/12/01 17:16
S21 3	61	ceramic.clm. and capillary.clm. and bonding.clm.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/12/01 17:16
S21 4	34	ceramic.clm. and capillary.clm. and "264"/\$8.ccls.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/12/01 17:16
S21 5	49	("2892924" "3538205" "3660050" "3986653" "4020543" "4171477" "4182947" "4315128" "4331048" "4387283" "4390771" "4502983" "4513190" "4691854" "4705204" "4897710" "4909427" "4998002" "5178742" "5180093" "5214259" "5217154" "5280979" "5290507" "5367956" "5463197" "5463896" "5491605" "5527441" "5544804" "5601740" "5616257" "5649355" "5651901" "5676856" "5797388" "5816472" "5827470" "5931368" "6030472" "6073827").PN. OR ("6354479"). URPN.	US-PGPUB; USPAT; USOCR	OR	OFF	2005/12/01 17:16
S21 6	18	ceramic.clm. and capillary.clm. and bonding.clm. and (binder or thermoplastic)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/12/01 17:16

EAST Search History

S21 7	3	"11156568"	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/12/01 17:16
S21 8	4	yamate.in. and color.clm.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/12/01 17:16
S21 9	7	65/111.ccls. and color.clm.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/12/01 17:16
S22 0	49	"5558270"	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/12/01 17:16
S22 1	76	"5421503"	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/12/01 17:16
S22 2	73	"5217154"	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/12/01 17:16
S22 3	11	"4667867"	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/12/01 17:16
S22 4	113	65/111.ccls. and color	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/12/01 17:16

EAST Search History

S22 5	165	photolithography and blanks and cutting	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/12/01 17:16
S22 6	1	10/082867	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/12/01 17:16
S22 7	0	"10389028"	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/12/01 17:32
S22 8	1	10/389028	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/12/01 17:32
S22 9	972	capillary.clm. and bonding.clm.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2006/03/28 12:46
S23 0	467	capillary.clm. and bonding.clm. and semiconductor	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2006/03/28 12:46
S23 1	226	capillary.clm. and bonding.clm. and semiconductor.clm.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2006/03/28 12:46
S23 2	79	capillary.clm. and bonding.clm. and semiconductor.clm. and tool	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2006/03/28 12:46

EAST Search History

S23 3	0	ceramic.clm. and capillary.in. and bonding.clm.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2006/03/28 12:46
S23 4	0	ceramic.clm. and capillary.in.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2006/03/28 12:46
S23 5	626	ceramic.clm. and capillary.clm.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2006/03/28 12:46
S23 6	200	ceramic.clm. and capillary.clm. and bonding	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2006/03/28 12:46
S23 7	65	ceramic.clm. and capillary.clm. and bonding.clm.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2006/03/28 12:46
S23 8	626	ceramic.clm. and capillary.clm.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2006/03/28 12:46
S23 9	38	ceramic.clm. and capillary.clm. and "264"/\$8.ccls.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2006/03/28 12:46
S24 0	200	ceramic.clm. and capillary.clm. and bonding	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2006/03/28 12:46

EAST Search History

S24 1	65	ceramic.clm. and capillary.clm. and bonding.clm.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2006/03/28 12:46
S24 2	58	ceramic.clm. and capillary.clm. and bonding.clm. and process	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2006/03/28 12:46
S24 3	50	("2892924" "3538205" "3660050" "3986653" "4020543" "4171477" "4182947" "4315128" "4331048" "4387283" "4390771" "4502983" "4513190" "4691854" "4705204" "4897710" "4909427" "4998002" "5178742" "5180093" "5214259" "5217154" "5280979" "5290507" "5367956" "5463197" "5463896" "5491605" "5527441" "5544804" "5601740" "5616257" "5649355" "5651901" "5676856" "5797388" "5816472" "5827470" "5931368" "6030472" "6073827").PN. OR ("6354479").URPN.	US-PGPUB; USPAT; USOCR	OR	OFF	2006/03/28 12:46
S24 4	15	"6374479"	US-PGPUB; USPAT; USOCR	OR	OFF	2006/03/28 12:46
S24 5	13	ceramic.clm. and capillary.clm. and bonding.clm. and binder	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2006/03/28 12:46
S24 6	21	ceramic.clm. and capillary.clm. and bonding.clm. and (binder or thermoplastic)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2006/03/28 12:46
S24 7	972	capillary.clm. and bonding.clm.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2006/03/28 12:46

EAST Search History

S24 8	467	capillary.clm. and bonding.clm. and semiconductor	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2006/03/28 12:46
S24 9	226	capillary.clm. and bonding.clm. and semiconductor.clm.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2006/03/28 12:46
S25 0	972	S247 or S248 or S249	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2006/03/28 12:46
S25 1	79	capillary.clm. and bonding.clm. and semiconductor.clm. and tool	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2006/03/28 12:46
S25 2	0	ceramic.clm. and capillary.in. and bonding.clm.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2006/03/28 12:46
S25 3	0	ceramic.clm. and capillary.in.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2006/03/28 12:46
S25 4	626	ceramic.clm. and capillary.clm.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2006/03/28 12:46
S25 5	200	ceramic.clm. and capillary.clm. and bonding	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2006/03/28 12:46

EAST Search History

S25 6	65	ceramic.clm. and capillary.clm. and bonding.clm.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2006/03/28 12:46
S25 7	626	ceramic.clm. and capillary.clm.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2006/03/28 12:46
S25 8	38	ceramic.clm. and capillary.clm. and "264"/\$8.ccls.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2006/03/28 12:46
S25 9	200	ceramic.clm. and capillary.clm. and bonding	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2006/03/28 12:46
S26 0	65	ceramic.clm. and capillary.clm. and bonding.clm.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2006/03/28 12:46
S26 1	58	ceramic.clm. and capillary.clm. and bonding.clm. and process	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2006/03/28 12:46
S26 2	15	"6374479"	US-PGPUB; USPAT; USOCR	OR	OFF	2006/03/28 12:46
S26 3	21	ceramic.clm. and capillary.clm. and bonding.clm. and (binder or thermoplastic)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2006/03/28 12:46
S26 4	318	264/669.ccls.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2006/03/28 12:46

EAST Search History

S26 5	250	264/670.ccls.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2006/03/28 12:46
S26 6	305	264/614.ccls.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2006/03/28 12:46
S26 7	109	264/629.ccls.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2006/03/28 12:46
S26 8	1444	228/4.5.ccls.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2006/03/28 12:46
S26 9	3	"11156568"	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2006/03/28 12:46
S27 0	4	yamate.in. and color.clm.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2006/03/28 12:46
S27 1	0	65/31.1.ccls.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2006/03/28 12:46
S27 2	0	65/31.11.ccls.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2006/03/28 12:46

EAST Search History

S27 3	857	65/111.ccls.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2006/03/28 12:46
S27 4	10	65/111.ccls. and color.clm.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2006/03/28 12:46
S27 5	117	65/111.ccls. and color	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2006/03/28 12:46
S27 6	174	photolithography and blanks and cutting	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2006/03/28 12:46
S27 7	50	"5558270"	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2006/03/28 12:46
S27 8	80	"5421503"	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2006/03/28 12:46
S27 9	75	"5217154"	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2006/03/28 12:46
S28 0	11	"4667867"	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2006/03/28 12:46

EAST Search History

S28 1	80	"5421503"	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2006/03/28 12:46
S28 2	8	"4049506"	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2006/03/28 12:46
S28 3	11	"5890643"	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2006/03/28 12:46
S28 4	2	"6409463"	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2006/03/28 12:46
S28 5	5	"6080445"	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2006/03/28 12:46
S28 6	5	"5741842"	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2006/03/28 12:46
S28 7	2	"20020158374"	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2006/03/28 12:46
S28 8	972	capillary.clm. and bonding.clm.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2006/03/28 12:46

EAST Search History

S289	467	capillary.clm. and bonding.clm. and semiconductor	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2006/03/28 12:46
S290	226	capillary.clm. and bonding.clm. and semiconductor.clm.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2006/03/28 12:46
S291	0	ceramic.clm. and capillary.in. and bonding.clm.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2006/03/28 12:46
S292	0	ceramic.clm. and capillary.in.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2006/03/28 12:46
S293	626	ceramic.clm. and capillary.clm.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2006/03/28 12:46
S294	200	ceramic.clm. and capillary.clm. and bonding	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2006/03/28 12:46
S295	626	ceramic.clm. and capillary.clm.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2006/03/28 12:46
S296	200	ceramic.clm. and capillary.clm. and bonding	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2006/03/28 12:46

EAST Search History

S29 7	65	ceramic.clm. and capillary.clm. and bonding.clm.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2006/03/28 12:46
S29 8	58	ceramic.clm. and capillary.clm. and bonding.clm. and process	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2006/03/28 12:46
S29 9	15	"6374479"	US-PGPUB; USPAT; USOCR	OR	OFF	2006/03/28 12:46
S30 0	13	ceramic.clm. and capillary.clm. and bonding.clm. and binder	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2006/03/28 12:46
S30 1	972	capillary.clm. and bonding.clm.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2006/03/28 12:46
S30 2	467	capillary.clm. and bonding.clm. and semiconductor	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2006/03/28 12:46
S30 3	226	capillary.clm. and bonding.clm. and semiconductor.clm.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2006/03/28 12:46
S30 4	972	S301 or S302 or S303	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2006/03/28 12:46
S30 5	79	capillary.clm. and bonding.clm. and semiconductor.clm. and tool	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2006/03/28 12:46

EAST Search History

S30 6	0	ceramic.clm. and capillary.in. and bonding.clm.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2006/03/28 12:46
S30 7	0	ceramic.clm. and capillary.in.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2006/03/28 12:46
S30 8	626	ceramic.clm. and capillary.clm.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2006/03/28 12:46
S30 9	200	ceramic.clm. and capillary.clm. and bonding	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2006/03/28 12:46
S31 0	65	ceramic.clm. and capillary.clm. and bonding.clm.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2006/03/28 12:46
S31 1	626	ceramic.clm. and capillary.clm.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2006/03/28 12:46
S31 2	38	ceramic.clm. and capillary.clm. and "264"/\$8.ccls.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2006/03/28 12:46
S31 3	200	ceramic.clm. and capillary.clm. and bonding	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2006/03/28 12:46

EAST Search History

S31 4	65	ceramic.clm. and capillary.clm. and bonding.clm.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2006/03/28 12:46
S31 5	58	ceramic.clm. and capillary.clm. and bonding.clm. and process	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2006/03/28 12:46
S31 6	15	"6374479"	US-PGPUB; USPAT; USOCR	OR	OFF	2006/03/28 12:46
S31 7	21	ceramic.clm. and capillary.clm. and bonding.clm. and (binder or thermoplastic)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2006/03/28 12:46
S31 8	318	264/669.ccls.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2006/03/28 12:46
S31 9	250	264/670.ccls.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2006/03/28 12:46
S32 0	305	264/614.ccls.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2006/03/28 12:46
S32 1	109	264/629.ccls.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2006/03/28 12:46
S32 2	1444	228/4.5.ccls.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2006/03/28 12:46

EAST Search History

S32 3	0	65/31.1.ccls.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2006/03/28 12:46
S32 4	0	65/31.11.ccls.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2006/03/28 12:46
S32 5	857	65/111.ccls.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2006/03/28 12:46
S32 6	79	capillary.clm. and bonding.clm. and semiconductor.clm. and tool	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2006/03/28 12:46
S32 7	65	ceramic.clm. and capillary.clm. and bonding.clm.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2006/03/28 12:46
S32 8	38	ceramic.clm. and capillary.clm. and "264"/\$8.ccls.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2006/03/28 12:46

EAST Search History

S32 9	50	("2892924" "3538205" "3660050" "3986653" "4020543" "4171477" "4182947" "4315128" "4331048" "4387283" "4390771" "4502983" "4513190" "4691854" "4705204" "4897710" "4909427" "4998002" "5178742" "5180093" "5214259" "5217154" "5280979" "5290507" "5367956" "5463197" "5463896" "5491605" "5527441" "5544804" "5601740" "5616257" "5649355" "5651901" "5676856" "5797388" "5816472" "5827470" "5931368" "6030472" "6073827").PN. OR ("6354479"). URPN.	US-PGPUB; USPAT; USOCR	OR	OFF	2006/03/28 12:46
S33 0	21	ceramic.clm. and capillary.clm. and bonding.clm. and (binder or thermoplastic)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2006/03/28 12:46
S33 1	3	"11156568"	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2006/03/28 12:46
S33 2	4	yamate.in. and color.clm.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2006/03/28 12:46
S33 3	10	65/111.ccls. and color.clm.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2006/03/28 12:46
S33 4	50	"5558270"	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2006/03/28 12:46

EAST Search History

S33 5	80	"5421503"	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2006/03/28 12:46
S33 6	75	"5217154"	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2006/03/28 12:46
S33 7	11	"4667867"	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2006/03/28 12:46
S33 8	117	65/111.ccls. and color	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2006/03/28 12:46
S33 9	174	photolithography and blanks and cutting	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2006/03/28 12:46
S34 0	1	10/082867	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2006/03/28 12:46
S34 1	184	264/610.ccls.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2006/03/28 12:46
S34 2	298	264/628.ccls.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2006/03/28 12:46

EAST Search History

S34 3	972	capillary.clm. and bonding.clm.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2006/03/28 12:46
S34 4	467	capillary.clm. and bonding.clm. and semiconductor	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2006/03/28 12:46
S34 5	226	capillary.clm. and bonding.clm. and semiconductor.clm.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2006/03/28 12:46
S34 6	0	ceramic.clm. and capillary.in. and bonding.clm.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2006/03/28 12:46
S34 7	0	ceramic.clm. and capillary.in.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2006/03/28 12:46
S34 8	626	ceramic.clm. and capillary.clm.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2006/03/28 12:46
S34 9	200	ceramic.clm. and capillary.clm. and bonding	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2006/03/28 12:46
S35 0	626	ceramic.clm. and capillary.clm.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2006/03/28 12:46

EAST Search History

S35 1	200	ceramic.clm. and capillary.clm. and bonding	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2006/03/28 12:46
S35 2	65	ceramic.clm. and capillary.clm. and bonding.clm.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2006/03/28 12:46
S35 3	58	ceramic.clm. and capillary.clm. and bonding.clm. and process	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2006/03/28 12:46
S35 4	15	"6374479"	US-PGPUB; USPAT; USOCR	OR	OFF	2006/03/28 12:46
S35 5	13	ceramic.clm. and capillary.clm. and bonding.clm. and binder	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2006/03/28 12:46
S35 6	972	capillary.clm. and bonding.clm.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2006/03/28 12:46
S35 7	467	capillary.clm. and bonding.clm. and semiconductor	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2006/03/28 12:46
S35 8	226	capillary.clm. and bonding.clm. and semiconductor.clm.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2006/03/28 12:46
S35 9	972	S356 or S357 or S358	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2006/03/28 12:46

EAST Search History

S36 0	79	capillary.clm. and bonding.clm. and semiconductor.clm. and tool	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2006/03/28 12:46
S36 1	0	ceramic.clm. and capillary.in. and bonding.clm.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2006/03/28 12:46
S36 2	0	ceramic.clm. and capillary.in.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2006/03/28 12:46
S36 3	626	ceramic.clm. and capillary.clm.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2006/03/28 12:46
S36 4	200	ceramic.clm. and capillary.clm. and bonding	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2006/03/28 12:46
S36 5	65	ceramic.clm. and capillary.clm. and bonding.clm.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2006/03/28 12:46
S36 6	626	ceramic.clm. and capillary.clm.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2006/03/28 12:46
S36 7	38	ceramic.clm. and capillary.clm. and "264"/\$8.ccls.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2006/03/28 12:46

EAST Search History

S36 8	200	ceramic.clm. and capillary.clm. and bonding	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2006/03/28 12:46
S36 9	65	ceramic.clm. and capillary.clm. and bonding.clm.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2006/03/28 12:46
S37 0	58	ceramic.clm. and capillary.clm. and bonding.clm. and process	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2006/03/28 12:46
S37 1	15	"6374479"	US-PGPUB; USPAT; USOCR	OR	OFF	2006/03/28 12:46
S37 2	21	ceramic.clm. and capillary.clm. and bonding.clm. and (binder or thermoplastic)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2006/03/28 12:46
S37 3	318	264/669.ccls.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2006/03/28 12:46
S37 4	250	264/670.ccls.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2006/03/28 12:46
S37 5	305	264/614.ccls.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2006/03/28 12:46
S37 6	109	264/629.ccls.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2006/03/28 12:46

EAST Search History

S37 7	1444	228/4.5.ccls.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2006/03/28 12:46
S37 8	0	65/31.1.ccls.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2006/03/28 12:46
S37 9	0	65/31.11.ccls.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2006/03/28 12:46
S38 0	857	65/111.ccls.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2006/03/28 12:46
S38 1	972	capillary.clm. and bonding.clm.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2006/03/28 12:46
S38 2	467	capillary.clm. and bonding.clm. and semiconductor	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2006/03/28 12:46
S38 3	226	capillary.clm. and bonding.clm. and semiconductor.clm.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2006/03/28 12:46
S38 4	0	ceramic.clm. and capillary.in. and bonding.clm.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2006/03/28 12:46

EAST Search History

S38 5	0	ceramic.clm. and capillary.in.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2006/03/28 12:46
S38 6	626	ceramic.clm. and capillary.clm.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2006/03/28 12:46
S38 7	200	ceramic.clm. and capillary.clm. and bonding	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2006/03/28 12:46
S38 8	626	ceramic.clm. and capillary.clm.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2006/03/28 12:46
S38 9	200	ceramic.clm. and capillary.clm. and bonding	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2006/03/28 12:46
S39 0	65	ceramic.clm. and capillary.clm. and bonding.clm.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2006/03/28 12:46
S39 1	58	ceramic.clm. and capillary.clm. and bonding.clm. and process	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2006/03/28 12:46
S39 2	15	"6374479"	US-PGPUB; USPAT; USOCR	OR	OFF	2006/03/28 12:46
S39 3	13	ceramic.clm. and capillary.clm. and bonding.clm. and binder	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2006/03/28 12:46

EAST Search History

S39 4	972	capillary.clm. and bonding.clm.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2006/03/28 12:46
S39 5	467	capillary.clm. and bonding.clm. and semiconductor	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2006/03/28 12:46
S39 6	226	capillary.clm. and bonding.clm. and semiconductor.clm.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2006/03/28 12:46
S39 7	972	S394 or S395 or S396	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2006/03/28 12:46
S39 8	79	capillary.clm. and bonding.clm. and semiconductor.clm. and tool	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2006/03/28 12:46
S39 9	0	ceramic.clm. and capillary.in. and bonding.clm.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2006/03/28 12:46
S40 0	0	ceramic.clm. and capillary.in.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2006/03/28 12:46
S40 1	626	ceramic.clm. and capillary.clm.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2006/03/28 12:46

EAST Search History

S40 2	200	ceramic.clm. and capillary.clm. and bonding	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2006/03/28 12:46
S40 3	65	ceramic.clm. and capillary.clm. and bonding.clm.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2006/03/28 12:46
S40 4	626	ceramic.clm. and capillary.clm.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2006/03/28 12:46
S40 5	38	ceramic.clm. and capillary.clm. and "264"/\$8.ccls.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2006/03/28 12:46
S40 6	200	ceramic.clm. and capillary.clm. and bonding	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2006/03/28 12:46
S40 7	65	ceramic.clm. and capillary.clm. and bonding.clm.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2006/03/28 12:46
S40 8	58	ceramic.clm. and capillary.clm. and bonding.clm. and process	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2006/03/28 12:46
S40 9	15	"6374479"	US-PGPUB; USPAT; USOCR	OR	OFF	2006/03/28 12:46
S41 0	21	ceramic.clm. and capillary.clm. and bonding.clm. and (binder or thermoplastic)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2006/03/28 12:46

EAST Search History

S41 1	318	264/669.ccls.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2006/03/28 12:46
S41 2	250	264/670.ccls.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2006/03/28 12:46
S41 3	305	264/614.ccls.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2006/03/28 12:46
S41 4	109	264/629.ccls.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2006/03/28 12:46
S41 5	1444	228/4.5.ccls.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2006/03/28 12:46
S41 6	0	65/31.1.ccls.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2006/03/28 12:46
S41 7	0	65/31.11.ccls.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2006/03/28 12:46
S41 8	857	65/111.ccls.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2006/03/28 12:46

EAST Search History

S41 9	1	10/082867	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2006/03/28 12:46
S42 0	79	capillary.clm. and bonding.clm. and semiconductor.clm. and tool	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2006/03/28 12:46
S42 1	65	ceramic.clm. and capillary.clm. and bonding.clm.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2006/03/28 12:46
S42 2	38	ceramic.clm. and capillary.clm. and "264"/\$8.ccls.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2006/03/28 12:46
S42 3	50	("2892924" "3538205" "3660050" "3986653" "4020543" "4171477" "4182947" "4315128" "4331048" "4387283" "4390771" "4502983" "4513190" "4691854" "4705204" "4897710" "4909427" "4998002" "5178742" "5180093" "5214259" "5217154" "5280979" "5290507" "5367956" "5463197" "5463896" "5491605" "5527441" "5544804" "5601740" "5616257" "5649355" "5651901" "5676856" "5797388" "5816472" "5827470" "5931368" "6030472" "6073827").PN. OR ("6354479"). URPN.	US-PGPUB; USPAT; USOCR	OR	OFF	2006/03/28 12:46
S42 4	21	ceramic.clm. and capillary.clm. and bonding.clm. and (binder or thermoplastic)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2006/03/28 12:46

EAST Search History

S42 5	3	"11156568"	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2006/03/28 12:46
S42 6	4	yamate.in. and color.clm.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2006/03/28 12:46
S42 7	10	65/111.ccls. and color.clm.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2006/03/28 12:46
S42 8	50	"5558270"	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2006/03/28 12:46
S42 9	80	"5421503"	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2006/03/28 12:46
S43 0	75	"5217154"	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2006/03/28 12:46
S43 1	11	"4667867"	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2006/03/28 12:46
S43 2	80	"5421503"	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2006/03/28 12:46

EAST Search History

S43 3	8	"4049506"	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2006/03/28 12:46
S43 4	11	"5890643"	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2006/03/28 12:46
S43 5	2	"6409463"	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2006/03/28 12:46
S43 6	5	"6080445"	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2006/03/28 12:46
S43 7	5	"5741842"	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2006/03/28 12:46
S43 8	2	"20020158374"	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2006/03/28 12:46
S43 9	79	capillary.clm. and bonding.clm. and semiconductor.clm. and tool	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2006/03/28 12:46
S44 0	65	ceramic.clm. and capillary.clm. and bonding.clm.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2006/03/28 12:46

EAST Search History

S44 1	38	ceramic.clm. and capillary.clm. and "264"/\$8.ccls.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2006/03/28 12:46
S44 2	50	("2892924" "3538205" "3660050" "3986653" "4020543" "4171477" "4182947" "4315128" "4331048" "4387283" "4390771" "4502983" "4513190" "4691854" "4705204" "4897710" "4909427" "4998002" "5178742" "5180093" "5214259" "5217154" "5280979" "5290507" "5367956" "5463197" "5463896" "5491605" "5527441" "5544804" "5601740" "5616257" "5649355" "5651901" "5676856" "5797388" "5816472" "5827470" "5931368" "6030472" "6073827").PN. OR ("6354479"). URPN.	US-PGPUB; USPAT; USOCR	OR	OFF	2006/03/28 12:46
S44 3	21	ceramic.clm. and capillary.clm. and bonding.clm. and (binder or thermoplastic)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2006/03/28 12:46
S44 4	3	"11156568"	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2006/03/28 12:46
S44 5	4	yamate.in. and color.clm.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2006/03/28 12:46
S44 6	10	65/111.ccls. and color.clm.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2006/03/28 12:46

EAST Search History

S44 7	50	"5558270"	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2006/03/28 12:46
S44 8	80	"5421503"	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2006/03/28 12:46
S44 9	75	"5217154"	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2006/03/28 12:46
S45 0	11	"4667867"	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2006/03/28 12:46
S45 1	117	65/111.ccls. and color	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2006/03/28 12:46
S45 2	174	photolithography and blanks and cutting	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2006/03/28 12:46
S45 3	117	65/111.ccls. and color	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2006/03/28 12:46
S45 4	174	photolithography and blanks and cutting	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2006/03/28 12:46